

| Dimensions |  |
| :---: | :---: |
| Chip Size | 0402 |
| L | $1 \mathrm{~mm}+/-0.05 \mathrm{~mm}$ |
| W | $0.5 \mathrm{~mm}+/-0.05 \mathrm{~mm}$ |
| T | $0.5 \mathrm{~mm}+/-0.05 \mathrm{~mm}$ |
| S | 0.3 mm MIN |
| B | $0.3 \mathrm{~mm}+/-0.1 \mathrm{~mm}$ |


| Packaging Specifications |  |
| ---: | :--- |
| Packaging: | T\&R, 180mm, Paper Tape |
| Packaging Quantity: | 10000 |


| General Information |  |
| ---: | :--- |
| Series: | SMD Comm X7R |
| Style: | SMD Chip |
| Description: | SMD, MLCC, Temperature <br> Stable, Class II |
| Features: | Temperature Stable, Class II |
| RoHS: | Yes |
| Termination: | Tin |
| Marking: | No |
| AEC-Q200: | No |
| Component Weight: | 1210 ug |
| Shelf Life: | 78 Weeks |
| MSL: | 1 |


| Specifications |  |
| :---: | :---: |
| Capacitance: | 12 pF |
| Measurement Condition: | 1 kHz 1.0 Vrms |
| Capacitance Tolerance: | 10\% |
| Voltage DC: | 50 VDC |
| Dielectric Withstanding Voltage: | 125 VDC |
| Temperature Range: | $-55 /+125^{\circ} \mathrm{C}$ |
| Temperature Coefficient: | X7R |
| Capacitance Change with Reference to $+25^{\circ} \mathrm{C}$ and 0 VDC Applied (TCC): | 15\%, 1kHz 1.0Vrms |
| Dissipation Factor: | 2.5\% 1 kHz 1.0Vrms |
| Aging Rate: | 3\% Loss/Decade Hour: Referee <br> Time is 1000 Hours |
| Insulation Resistance: | 100 GOhms |

